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IP4264CZ8-10/20/40-TTL

Integrated (U)SIM card passive filter array with ESD protection

Rev. 2 — 12 October 2011

Product data sheet

1. Product profile

1.1 General description

The IP4264CZ8-10-TTL, IP4264CZ8-20-TTL and IP4264CZ8-40-TTL are 3-channel RC low-pass filter arrays. They are designed to provide filtering of undesired RF signals in the 800 MHz-to-3000 MHz frequency band. They incorporate diodes to provide protection to downstream components from ElectroStatic Discharge (ESD) voltages up to ± 25 kV contact and higher than ± 25 kV air discharge, far exceeding IEC 61000-4-2, level 4.

The devices support ESD protection of the USB data pins of a Universal Subscriber Identity Module (USIM) interface, as well as the digital standard SIM interface ESD protection and ElectroMagnetic Interface (EMI) filtering.

The devices are fabricated using monolithic silicon technology. They integrate three resistors and eight high-level ESD protection diodes in a 0.4 mm pitch Quad Flat-pack No-leads (QFN) plastic package with a height of only 0.5 mm. These features make all three devices ideal for use in applications requiring component miniaturization, such as mobile phone handsets, cordless telephones and personal digital devices.

Similar products are available in Wafer Level Chip-Size Package (WLCSP). IP4365CX11/P (0.4 mm pitch, 11-ball WLCSP11) is designed for USIM interfaces. IP4364CX8 (0.4 mm pitch, 8-ball WLCSP8) and IP4064CX8 (0.5 mm pitch, 8-ball WLCSP8) are designed for SIM interfaces.

1.2 Features and benefits

- Pb-free, Restriction of Hazardous Substances (RoHS) compliant and free of halogen and antimony (Dark Green compliant)
- 3-channel SIM card interface integrated RC-filter array and SIM voltage ESD protection
- 2 USIM (USB 1.1) compliant ESD protection diodes with 20 pF channel capacitance
- Integrated 100 Ω /100 Ω /47 Ω series channel resistors
- Total channel capacitance of 10 pF (IP4264CZ8-10-TTL), 20 pF (IP4264CZ8-20-TTL) or 40 pF (IP4264CZ8-40-TTL)
- Downstream ESD protection up to ±25 kV (contact) according to IEC 61000-4-2
- Micropak (QFN compatible) plastic package with 0.4 mm pitch

1.3 Applications

 SIM interfaces in for example, cellular phone and Personal Communication System (PCS) mobile handsets



2. Pinning information

Table 1. Pinning

Table 1.	Filling		
Pin	Description	Simplified outline	Graphic symbol
1 and 8	filter channel 1		
2 and 7	filter channel 2	- 8 5 [UUUU]	1 R1 8
3 and 6	filter channel 3		100 Ω
4 and 5	ESD protection	1 4	2 R2 7
GND	ground	Transparent top view	3 47 Ω R3 100 Ω 5
			018aaa015

3. Ordering information

Table 2. Ordering information

Type number	Package				
	Name	Description	Version		
IP4264CZ8-10-TTL	HUSON8	plastic thermal enhanced extremely thin small outline package;	SOT1166-1		
IP4264CZ8-20-TTL		no leads; 8 terminals; body $1.35 \times 1.7 \times 0.55$ mm			
IP4264CZ8-40-TTL					

4. Marking

Table 3. Marking codes

Type number	Marking code
IP4264CZ8-10-TTL	N1
IP4264CZ8-20-TTL	N2
IP4264CZ8-40-TTL	N4

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
IP4264CZ8	3-10-TTL				
V _{ESD}	electrostatic discharge	pins 1, 2 and 3 to ground	[1]		
	voltage	contact discharge	-10	+10	kV
		air discharge	-15	+15	kV
		pins 6, 7 and 8 to ground	[1]		
		contact discharge	-8	+8	kV
		air discharge	-15	+15	kV
		pins 5 and 6 to ground	[1]		
		contact discharge	-15	+15	kV
		air discharge	-15	+15	kV
IP4264CZ8	3-20-TTL				
V _{ESD}	electrostatic discharge voltage	all pins to ground	[1]		
		contact discharge	-15	+15	kV
		air discharge	-15	+15	kV
IP4264CZ8	3-40-TTL				
V_{ESD}	electrostatic discharge voltage	all pins to ground	<u>[1]</u>		
		contact discharge	-25	+25	kV
		air discharge	-25	+25	kV
IP4264CZ8	3-10-TTL, IP4264CZ8-20-	TTL and IP4264CZ8-40-TT	L		
V _{ESD}	electrostatic discharge voltage	IEC 61000-4-2, level 4; all pins to ground			
		contact discharge	-8	+8	kV
		air discharge	-15	+15	kV
V _I	input voltage	at I/O pins	-0.5	+5.5	V
P _{ch}	channel power dissipation	T _{amb} = 70 °C	-	60	mW
P _{tot}	total power dissipation	T _{amb} = 70 °C	-	180	mW
T _{stg}	storage temperature		-55	+150	°C
T _{reflow(peak)}	peak reflow temperature	$t_p \le 10 \text{ s}$	-	260	°C
T _{amb}	ambient temperature		-30	+85	°C

^[1] All devices are qualified using 1000 contact discharges of ±8 kV (IP4264CZ8-10-TTL and IP4264CZ8-20-TTL) or ±25 kV (IP4264CZ8-40-TTL) using the IEC 61000-4-2 model, far exceeding the specified IEC 61000-4-2, level 4 (8 kV contact discharge).

6. Characteristics

Table 5. Channel resistance

 $T_{amb} = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{s(ch)}		R1, R3	85	100	115	Ω
	resistance	R2	40	47	54	Ω

Table 6. Channel characteristics

 $T_{amb} = 25$ °C unless otherwise specified.

	<u> </u>					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I_{RM}	reverse leakage current	$V_I = 3 V$	-	-	50	nA
V_{BR}	breakdown voltage	$I_{test} = 1 \text{ mA}$	6	-	10	V
IP4264CZ	8-10-TTL					
C _{ch}	channel capacitance	f = 1 MHz	[1][2]			
		$V_{\text{bias}(DC)} = 0 \text{ V}$	8	10	12	pF
		$V_{\text{bias}(DC)} = 2.5 \text{ V}$	4	6	8	pF
C _d	diode capacitance	f = 1 MHz	[1][3]			
		$V_{bias(DC)} = 0 V$	8	10	12	pF
		$V_{\text{bias}(DC)} = 2.5 \text{ V}$	4	6	8	pF
IP4264CZ	8-20-TTL					
C _{ch}	channel capacitance	f = 1 MHz	[1][2]			
		$V_{bias(DC)} = 0 V$	-	17	20	pF
		$V_{\text{bias}(DC)} = 2.5 \text{ V}$	-	11	15	pF
IP4264CZ	8-40-TTL					
C _{ch}	channel capacitance	f = 1 MHz	[1][2]			
		$V_{bias(DC)} = 0 V$	-	35	40	pF
		$V_{\text{bias}(DC)} = 2.5 \text{ V}$	-	23	28	pF
IP4264CZ	8-20-TTL and IP4264C	Z8-40-TTL				
C _d	diode capacitance	f = 1 MHz	<u>[3]</u>			
		$V_{bias(DC)} = 0 V$	12	16	20	pF

^[1] Guaranteed by design.

^[2] Total line capacitance including diode capacitance, per channel.

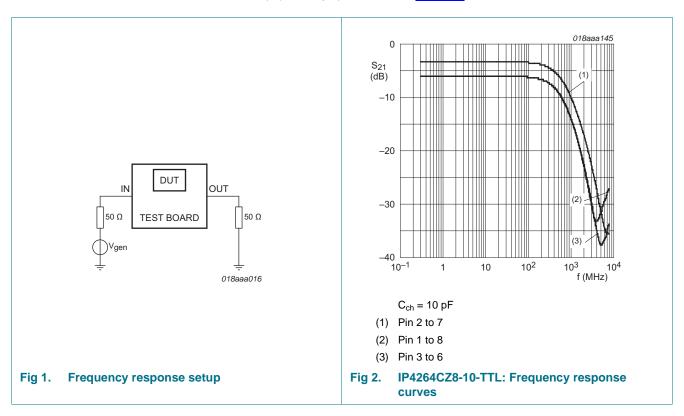
^[3] Pins 4 and 5 to ground.

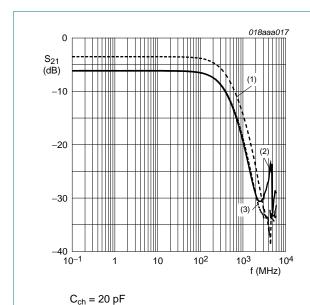
7. Application information

7.1 Insertion loss

The devices are designed as EMI/Radio Frequency Interference (RFI) filters for SIM card interfaces. The setup for measuring return loss is shown in <u>Figure 1</u>.

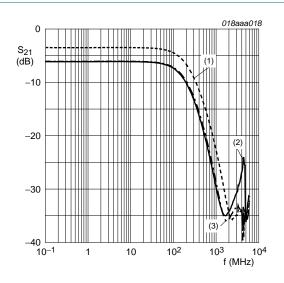
The insertion loss in a 50 Ω system for all three channels of IP4264CZ8-10-TTL (C_{ch} = 10 pF) is shown in <u>Figure 2</u>. The same measurements for IP4264CZ8-20-TTL (C_{ch} = 20 pF) are shown in <u>Figure 3</u>. The insertion loss for IP4264CZ8-40-TTL (C_{ch} = 10 pF) is shown in <u>Figure 4</u>.





- O_{ch} 20 p
- (1) Pin 2 to 7
- (2) Pin 1 to 8
- (3) Pin 3 to 6

Fig 3. IP4264CZ8-20-TTL: Frequency response curves



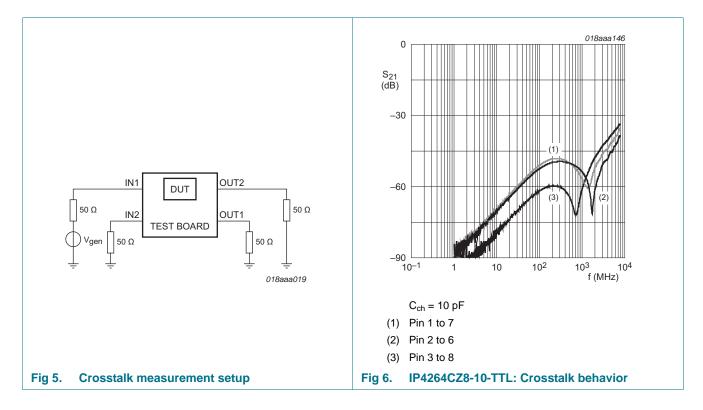
- $C_{ch} = 40 pF$
- (1) Pin 2 to 7
- (2) Pin 1 to 8
- (3) Pin 3 to 6

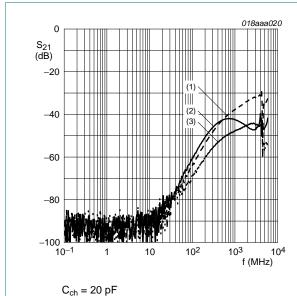
Fig 4. IP4264CZ8-40-TTL: Frequency response curves

7.2 Crosstalk

The setup for measuring crosstalk between channels in a 50 Ω system is shown in Figure 5. The crosstalk for IP4264CZ8-10-TTL is shown in Figure 6, for IP4264CZ8-20-TTL in Figure 7 and for IP4264CZ8-40-TTL in Figure 8. Unused channels are terminated with a 50 Ω resistor to ground.

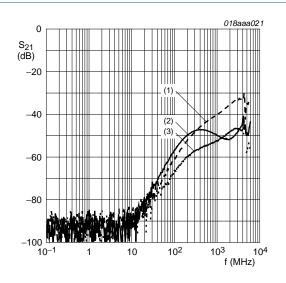
The crosstalk between any pin and pin 4 and pin 5 is similar to the crosstalk between the channels.





- Ocn 20 P
- (1) Pin 1 to 7
- (2) Pin 2 to 6
- (3) Pin 3 to 8

Fig 7. IP4264CZ8-20-TTL: Crosstalk behavior



- $C_{ch} = 40 pF$
- (1) Pin 1 to 7
- (2) Pin 2 to 6
- (3) Pin 3 to 8

Fig 8. IP4264CZ8-40-TTL: Crosstalk behavior

7.3 USIM and SIM interface application schematic

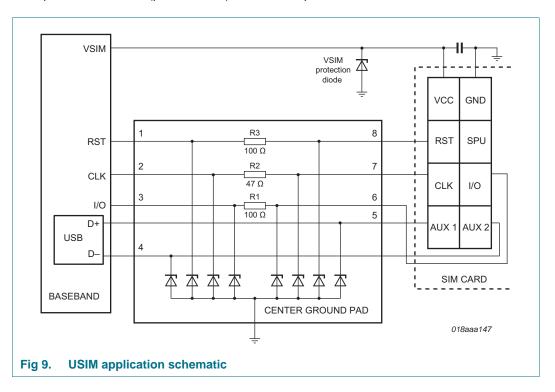
The application schematic diagram depicted in <u>Figure 9</u> demonstrates how the three NXP SIM card EMI filter and ESD protection devices are used in a typical USIM interface application.

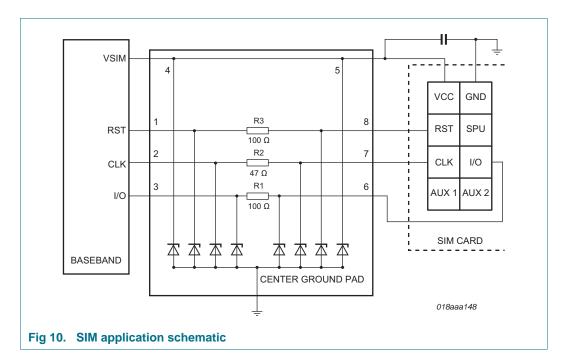
For example, in case a standard SIM interface without USB 1.1 is used, the two single diodes (pins 4 and 5) can protect the VSIM line.

It is only one example dependent on layout constraints. For example, channels 1 to 8 can be swapped with channels 3 to 6.

Also, the USB interface ESD protection pins 4 and 5 can be exchanged. Due to both sides of the devices containing identical protection diodes, baseband and SIM card side can be swapped, too (pin 1 with pin 8, pin 2 with pin 7 etc.).

A standard SIM interface application is depicted in <u>Figure 10</u>. In this case, both ESD protection diodes (pins 1 and 8) are used to protect VSIM.





7.4 Compatible devices in WLCSP

The IP4264CZ8-10-TTL and IP4264CZ8-20-TTL are optimized for SIM and USIM interfaces. Comparable devices are also available in WLCSP:

- IP4064CX8, 0.5 mm pitch SIM interface device compatible with IP4264CZ8-20-TTL
- IP4364CX8, 0.4 mm pitch SIM interface device compatible with IP4264CZ8-20-TTL
- IP4366CX8/P, 0.4 mm pitch SIM interface device compatible with IP4264CZ8-10-TTL
- IP4365CX11/P, 0.4 mm pitch USIM interface device compatible with IP4264CZ8-10-TTL

8. Package outline

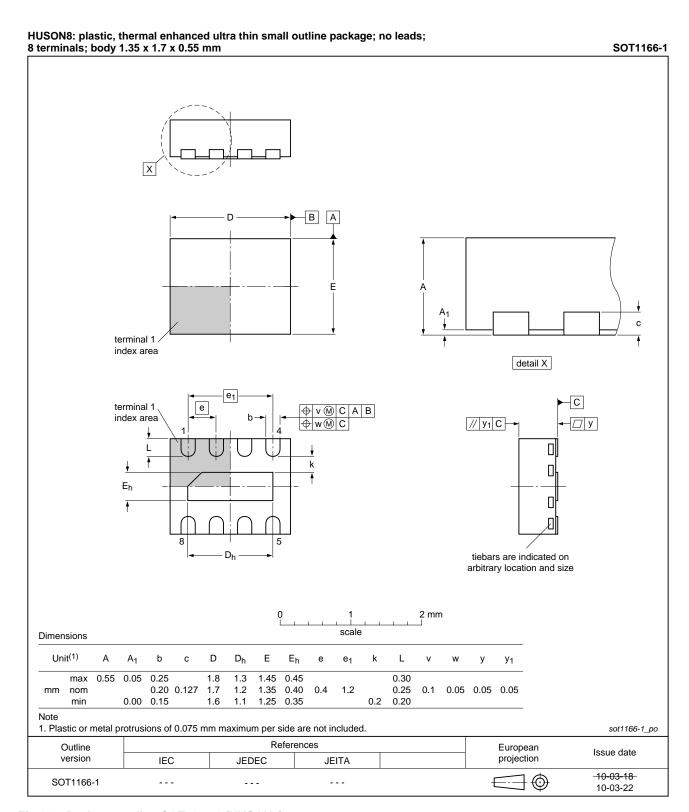


Fig 11. Package outline SOT1166-1 (HUSON8)

IP4264CZ8-10_20_40-TTL

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9. Revision history

Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
IP4264CZ8-10_20_40-TTL v.2	20111012	Product data sheet	-	IP4264CZ8-10_20_40-TTL v.1
Modifications:	• Figure 2: co	rrected title		
	 Section 10 ' 	'Legal information": upd	ated	
IP4264CZ8-10_20_40-TTL v.1	20110708	Product data sheet	-	-

10. Legal information

10.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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IP4264CZ8-10/20/40-TTL

Integrated (U)SIM card passive filter array with ESD protection

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